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APPLICATION NO.	1	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
09/853,111	9/853,111 05/10/2001		Salman Akram	MICT-0012-D1-US (97-0141)	7172	
21906	7590	01/16/2002				
TROP PRU	JNER &	HU, PC	EXAMINER			
8554 KATY FREEWAY SUITE 100				CHAMBLISS	CHAMBLISS, ALONZO	
HOUSTON, TX 77024		)24		ART UNIT	PAPER NUMBER	
				2827		
				DATE MAILED: 01/16/2002	!	

Please find below and/or attached an Office communication concerning this application or proceeding.

			γS				
		Application No.	Applicant(s)				
	Office Action Summer	09/853,111	SALMAN AKRAM				
	Office Action Summary	Examiner	Art Unit				
	The MAIL INC DATE of this communication	Alonzo Chambliss	2814				
	The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply						
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.  - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.  - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133).  - Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).  Status							
1)⊠	Responsive to communication(s) filed on 10	<u>May 2001</u> .					
2a) <u></u> □	This action is <b>FINAL</b> . 2b)⊠ Th	nis action is non-final.					
3) 🗌	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.						
Dispositi	on of Claims						
4)⊠ Claim(s) <u>1-31</u> is/are pending in the application.							
4a) Of the above claim(s) <u>1-14 and 23-31</u> is/are withdrawn from consideration.							
5) Claim(s) is/are allowed.							
6)⊠	Claim(s) <u>15-22</u> is/are rejected.						
7) 🗌	Claim(s) is/are objected to.						
8) 🗌	Claim(s) are subject to restriction and/o	or election requirement.					
Applicati	on Papers						
9)⊠ The specification is objected to by the Examiner.							
10)⊠ The drawing(s) filed on <u>10 May 2001</u> is/are: a)⊡ accepted or b)⊠ objected to by the Examiner.							
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).							
11) 🗌 -	The proposed drawing correction filed on		oved by the Examiner.				
If approved, corrected drawings are required in reply to this Office action.							
,	The oath or declaration is objected to by the Ex	xaminer.					
Priority under 35 U.S.C. §§ 119 and 120							
13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).							
a) All b) Some * c) None of:							
	1. Certified copies of the priority documents have been received.						
	2. Certified copies of the priority documents have been received in Application No						
<ul> <li>Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).</li> <li>* See the attached detailed Office action for a list of the certified copies not received.</li> </ul>							
14) ☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).							
a) ☐ The translation of the foreign language provisional application has been received. 15)☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121.							
Attachment(s)							
2) 🔲 Notic	e of References Cited (PTO-892) e of Draftsperson's Patent Drawing Review (PTO-948) nation Disclosure Statement(s) (PTO-1449) Paper No(s) _	5) Notice of Informal	ry (PTO-413) Paper No(s) Patent Application (PTO-152)				
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#### **DETAILED ACTION**

1. Claims 1-14 and 23-31 have been canceled.

### Drawings

2. The drawings are objected to as failing to comply with 37 CFR 1.84(p)(5) because they do not include the following reference sign(s) mentioned in the description: die 100 on page 8 line 5. Also, the drawings are objected to because they include the following reference sign(s) not mentioned in the description: 23, 24, 33, 34, 62, and 183. A proposed drawing correction, corrected drawings, or amendment to the specification to add the reference sign(s) in the description, are required in reply to the Office action to avoid abandonment of the application. The objection to the drawings will not be held in abeyance.

## Specification

- 3. The abstract of the disclosure is objected to because one of the essential elements in the applicant's invention (i.e. spacer) is not defined in the abstract.

  Correction is required. See MPEP § 608.01(b).
- 4. The title of the invention is not descriptive. A new title is required that is clearly indicative of the invention to which the claims are directed. The following title is suggested: "METHOD OF FABRICATING MOUNTED MULTIPLE SEMICONDUCTOR DIES IN A PACKAGE".

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## Claim Rejections - 35 USC § 112

5. The following is a quotation of the second paragraph of 35 U.S.C. 112:

The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.

- 6. Claims 16 and 17 are rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.
- 7. In claim 16, the phrase "a first and a second semiconductor dies "is vague and indefinite since it is not clear if the first and second dies are additional dies added to the semiconductor package or if the first and second dies are the two semiconductor dies in claim 15.

## Claim Rejections - 35 USC § 102

8. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(e) the invention was described in a patent granted on an application for patent by another filed in the United States before the invention thereof by the applicant for patent, or on an international application by another who has fulfilled the requirements of paragraphs (1), (2), and (4) of section 371(c) of this title before the invention thereof by the applicant for patent.

The changes made to 35 U.S.C. 102(e) by the American Inventors Protection Act of 1999 (AIPA) do not apply to the examination of this application as the application being examined was not (1) filed on or after November 29, 2000, or (2) voluntarily published under 35 U.S.C. 122(b). Therefore, this application is examined under 35 U.S.C. 102(e) prior to the amendment by the AIPA (pre-AIPA 35 U.S.C. 102(e)).

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9. Claims15-22, **insofar as some of them being definite**, are rejected under 35 U.S.C. 102(e) as being anticipated by Ball (U.S. 5,917,242).

With respect to Claims 15 and 21, Ball teaches stacking at least two semiconductor dies 102, 104 having substantially the same rectangular dimensions on top of one another. The dies 102, 104 are electrically connected to the lead frame 120. Bonding pads 116, 122, 128, 136 of the dies 102, 104 are electrically connected to the lead fingers 118, 130 of the lead frame 120 (see Fig. 3).

With respect to Claim 16, the first die 102 is mounted on the back to back on a second die 104 (see Fig. 3).

With respect to Claim 17, the first die 102 is adhered to the second die 104 by an adhesive layer 110 (see col. 7 lines 1-6; Fig. 3).

With respect to Claim 18, the first die 102 has a lead on chip configuration (see Fig. 3).

With respect to Claim 19, semiconductor die 102 is secured to the lead frame 120 and the other of the dies 104 is secured to the die secured to the lead frame 120 (see Fig. 3).

With respect to Claim 20, the semiconductor dies 42, 70 are wire bonded to the lead frame 58, wherein the dies 42, 70 have facing sides and outwardly facing sides by extending wire to bond pads 64, 74 on the outwardly facing sides of the dies (see Fig.

- 2). The outwardly facing sides are the edges of the die that is closest to the lead fingers
- 82. Therefore, the wires extend toward the outwardly facing side of the dies 42, 70.

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#### Conclusion

10. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. It is cited primarily to show processes of packaging a semiconductor device, which are similar to the process of the instant invention.

Any inquiry concerning the communication or earlier communications from the examiner should be directed to Alonzo Chambliss whose telephone number is (703) 306-9143. The fax phone number for this Group is (703) 308-7722 or 7724.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the Group receptionist whose telephone number is (703) 308-7956.

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AC/January 12, 2002